



Atomic Layer Deposition: From Thin Films to Nanostructured Materials

Guest Editor:

Dr. Mikhael Bechelany

European Institute of Membranes
(IEM), University of Montpellier,
34090 Montpellier, France

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Message from the Guest Editor

Atomic layer deposition (ALD) is an ultrathin film deposition method. This technique allows the deposition of various materials (oxides, nitrides, metals, etc.) with a thickness control at the nanometric scale, as well as excellent uniformity and conformality.

The aim of this Special Issue is to assemble high-quality contributions on the deposition of thin films as well as the synthesis and modification of nanostructures using ALD. It will deal with the design of new thin films and nanostructures by tuning their morphology, geometry, crystallinity, and interfaces. The relation between these parameters and the physical–chemical properties will also be investigated. New applications in different fields, such as health, the environment, renewable energy, microelectronics, etc., will be also explored.

Relevant contributions related to prospective materials' design, original materials' properties, and innovative characterization techniques will also be considered.





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Editor-in-Chief

Prof. Dr. Maryam Tabrizian

1. Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada

2. Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

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Materials Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

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